

RL78/G14

7-Segment LED Lighting Control (Arduino API)

Introduction

This application note describes a method to control dynamically lighting of 7-segment LEDs using a program written in an Arduino language using the RL78/G14 Fast Prototyping Board (FPB).

Target Device

RL78/G14

When applying the sample program covered in this application note to another microcomputer, modify the program according to the specifications for the target microcomputer and conduct an extensive evaluation of the modified program.

Contents

1. Specifications	3
1.1 Program Execution Environment.....	4
1.2 Program (Sketch) Configuration.....	5
1.3 Preparations for Project Startup	5
1.4 Definitions in the Program (sketch)	6
1.5 Initial Setting Processing	8
1.6 Main Processing Part	8
2. Operating Conditions	9
3. Related Application Notes	9
4. Hardware	10
4.1 Example of Hardware Configuration	10
4.2 List of Pins Used	10
5. Software	11
5.1 Summary of Operation	11
(1) Pins to be used are set in the setup function.	11
(2) The main processing is performed in the loop function.	11
(3) In the poll_sw function, the state of the SW_USR switch is confirmed every 10 milliseconds, and the number of times the switch is pressed is counted.	12
5.2 List of Constants	13
5.3 List of Variables	14
5.4 List of Functions	15
5.5 Specification of Functions	16
5.6 Flowcharts	18
5.6.1 Initial setting function	18
5.6.2 Main Processing Function	20
5.6.3 Function to set display data for 7-segment LEDs	24
6. Sample Code	26
7. Reference Documents	26
Revision History	27

1. Specifications

In this application note, an FPB is used with a program written in an Arduino language to dynamically control lighting of three 7-segment LEDs (cathode-common) and eight LEDs that are externally connected to the FPB.

The 7-segment LEDs realize a one-minute timer that displays an elapsed time in 100-millisecond (0.1 second) units. Upon the passing of each minute, the eight LEDs are lit in sequence, to realize a timer that can measure times up to nine minutes. Moreover, the timer counting operation can be controlled using a switch (SW_USR) mounted on the FPB or using an externally connected switch (ex_SW).

Table 1.1 shows peripheral functions used in this program and their uses.

Table 1.1 Peripheral functions used and their uses

Peripheral Function	Use
Digital input	Reading the state of the switch (SW_USR) or external switch (ex_SW)
Digital output	Control of the LEDs (three 7-segment LEDs and eight separate LEDs)
Timer array unit	Measurement of the elapsed time

1.1 Program Execution Environment

In this application note, a program in an Arduino language is executed in a development environment specific to the RL78 family. A conceptual diagram of the program execution environment is shown in Figure 1.1.

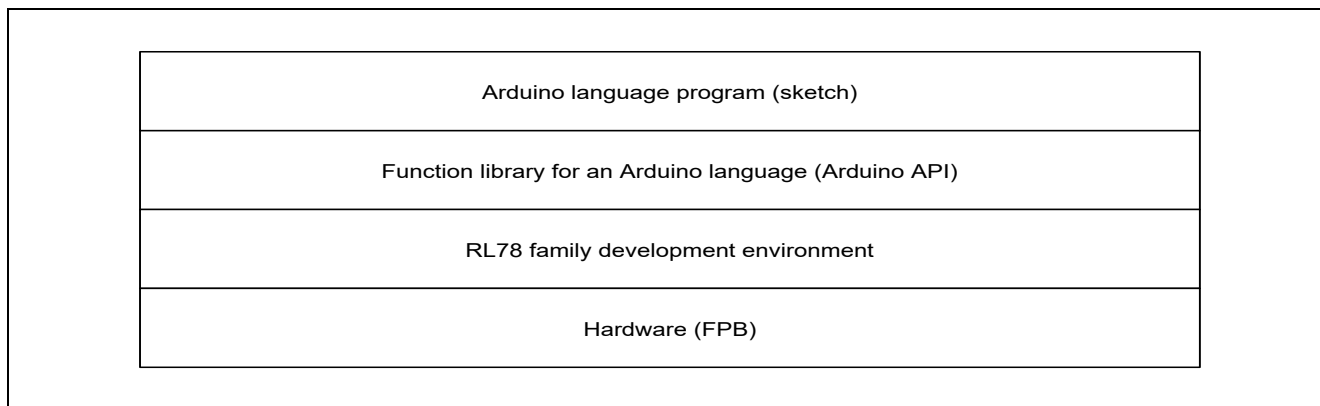


Figure 1.1 Program execution environment

Library functions that can be used in this application note are shown in Table 1.2.

Table 1.2 Library functions

Item	Library Function	Function
Digital I/O	pinMode(pin, mode)	Specifies the operation mode (input mode/output mode/input mode with internal pull-up resistor enabled) for the pin specified by "pin".
	digitalWrite (pin, value)	Sets the pin specified by "pin" to the state specified by "value" (high level/low level).
	digitalRead(pin)	Reads out the state of the pin specified by "pin".
Time control	millis()	Returns, in millisecond units, the time from the start of program execution to the present time.
	micros()	Returns, in microsecond units, the time from the start of program execution to the present time.
	delay (ms)	Stops the program for the specified time in millisecond units.
	delayMicroseconds (us)	Stops the program for the specified time in microsecond units.

1.2 Program (Sketch) Configuration

Subfolders are prepared for each integrated development environment below the folder (workspace) in which the project is stored. In the folders for each of the integrated development environments the files are stored that are used in the RL78 family development environment.

In each sketch subfolder, AR_SKETCH.c is stored which is the Arduino language program (sketch). When viewing or modifying sketch, the "AR_SKETCH.c" file in the sketch subfolder is used.

1.3 Preparations for Project Startup

Preparations for project startup are different depending on the integrated development environment used. For details, refer to the following application note.

RL78 Family Arduino API Introduction Guide (R01AN5413)

1.4 Definitions in the Program (sketch)

Definitions in the program (sketch) are indicated in Figure 1.2.

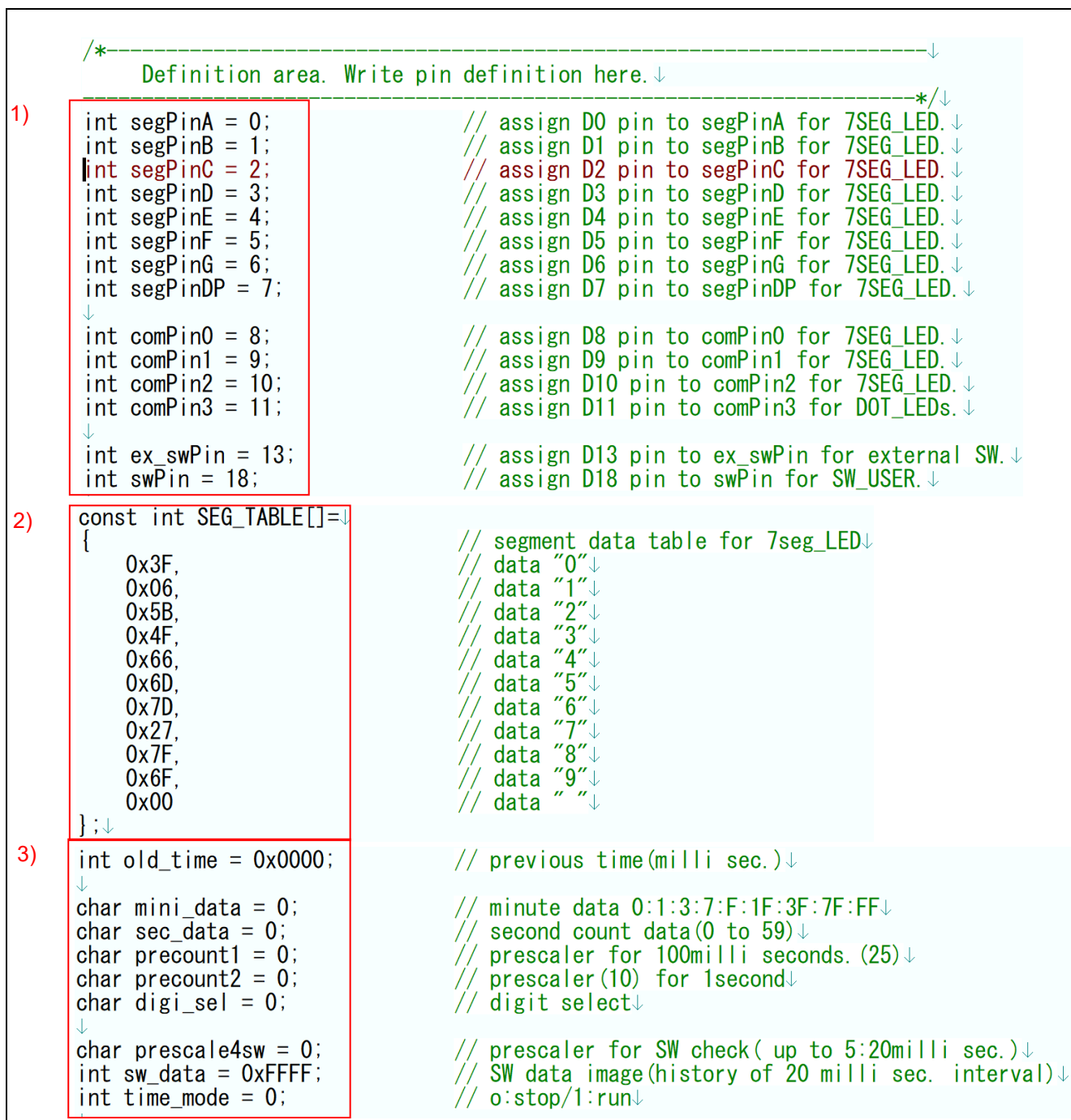


Figure 1.2 Program definition details

- 1) The digital output pins used to drive segments of the 7-segment LEDs are defined.

0 is specified for the segPinA pin, which controls segment A, allocating this pin to D0.

Similarly, segments B, C, D, E, F, G, and DP are defined.

The digital output pins used to drive commons (for selecting the LED display digits) of the 7-segment LEDs are defined.

8 is specified for the comPin0 pin, which controls the 10-second digit, allocating this pin to D8.

9 is specified for the comPin1 pin, which controls the 1-second digit, allocating this pin to D9.

10 is specified for the comPin2 pin, which controls the 0.1-second digit, allocating this pin to D10.

11 is specified for the comPin3 pin, which controls eight separate LEDs, allocating this pin to D11.

The digital input pins used to read the states of the switches are defined.

13 is specified for the ex_swPin pin, which controls the external switch, allocating this pin to D13.

18 is specified for the swPin pin, which controls the on-board switch (SW_USR), allocating this pin to D18.

- 2) Control data is defined using the array SEG_TABLE, which specifies the numerals (0 to 9) to be displayed by the 7-segment LEDs and specifies where there is no display (LED extinguished).

- 3) A number of variables used in the program (sketch) are defined.

old_time : Variable to confirm the elapsed time (in milliseconds)

sec_data : Variable to count seconds

mini_data : Variable to count minutes

precount1 : Counter variable to obtain 100 milliseconds from the timing of switching of the 4-millisecond display digit

precount2 : Variable to obtain 1 second by counting 100 milliseconds

digi_sel : Variable to control display dynamically

prescale4sw : Variable to count timing to confirm the switch state

sw_data : Variable to store change of the switch state

time_mode : Variable to start/stop counting time

1.5 Initial Setting Processing

The initial settings section of the program (sketch) is shown in Figure 1.3.

In the setup function, input or output mode is specified for each pin.

```

/*-----↓
  Arduino setup area. Write setup program here. ↓
-----*/

↓
void setup(void) {↓
  // put your setup code here, to run once:↓
  pinMode(segPinA, OUTPUT); // set D0pin to output mode↓
  pinMode(segPinB, OUTPUT); // set D1pin to output mode↓
  pinMode(segPinC, OUTPUT); // set D2pin to output mode↓
  pinMode(segPinD, OUTPUT); // set D3pin to output mode↓
  pinMode(segPinE, OUTPUT); // set D4pin to output mode↓
  pinMode(segPinF, OUTPUT); // set D5pin to output mode↓
  pinMode(segPinG, OUTPUT); // set D6pin to output mode↓
  pinMode(segPinDP, OUTPUT); // set D7pin to output mode↓
  pinMode(comPin0, OUTPUT); // set D8pin to output mode↓
  pinMode(comPin1, OUTPUT); // set D9pin to output mode↓
  pinMode(comPin2, OUTPUT); // set D10pin to output mode↓
  pinMode(comPin3, OUTPUT); // set D11pin to output mode↓
  pinMode(ex_swPin, INPUT_PULLUP); // set D13pin to input mode↓
  pinMode(swPin, INPUT); // set D18pin to input mode↓
}↓

```

Figure 1.3 Initial setting processing section

1.6 Main Processing Part

The leading section of the main processing, which is executed repeatedly, is shown in Figure 1.4. When preparations for project startup have been set correctly, the startup screen is as in Figure 1.4.

```

void loop(void){
  // put your main code here, to run repeatedly:

  int time_work; // present time buffer
  char com_sel; // common select signal
  char seg_data; // segment data
  char sw_work; // work for switch check

  /*-----
    wait for 4milli seconds interval.
  -----*/

  time_work = ( int )( millis() & 0xFFC ); // read milli sec data

  if ( old_time != time_work ) // check timing of change LED
  {

```

Figure 1.4 Leading section of main processing

2. Operating Conditions

The operation of the sample code provided with this application note has been tested under the following conditions.

Table 2.1 Operating conditions

Item	Description
Microcontroller used	RL78/G14 (R5F104MLAFB)
Operating frequency	<ul style="list-style-type: none"> ● High-speed on-chip oscillator clock (f_{IH}): 32 MHz ● CPU/peripheral hardware clock: 32 MHz
Operating voltage	3.3 V (can be operated at 2.75 V to 5.5 V) LVD operation: Reset mode LVD detection voltage (V_{LVD}) At rising edge: 2.81 V typ. (2.76 V to 2.87 V) At falling edge: 2.75 V typ. (2.70 V to 2.81 V)
Integrated development environment	Renesas Electronics CS+ for CC V8.03.00 Renesas Electronics e ² studio V7.7.0 IAR Systems IAR Embedded Workbench for RL78
C compiler	Renesas Electronics CC-RL V1.09.00 IAR Systems IAR C/C++ Compiler v4.20.1 for RL78

3. Related Application Notes

The application notes related to this application note are shown below.

Refer to these together with this application note.

RL78 Family Arduino API Introduction Guide (R01AN5413)

RL78/G14 Onboard LED Flashing Control (Arduino API) (R01AN5384)

4. Hardware

4.1 Example of Hardware Configuration

Figure 4.1 shows the hardware (FPB) that is used in this application note.

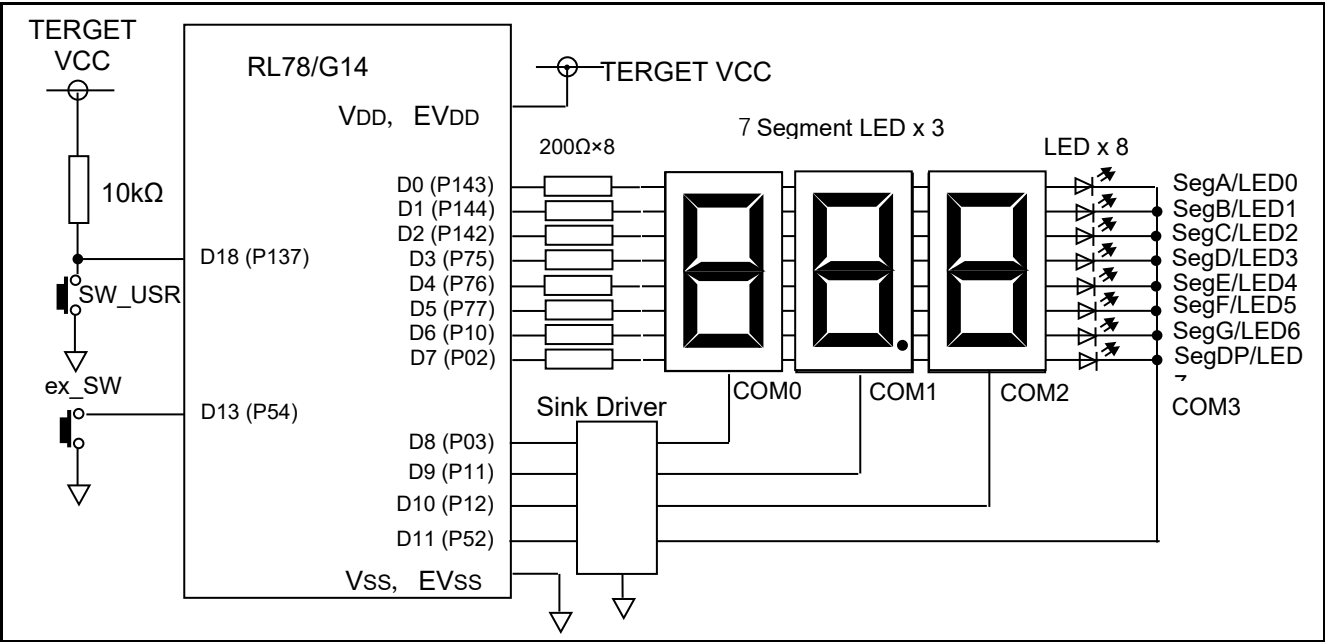


Figure 4.1 Hardware configuration example

Note: This conceptual diagram is simplified in order to summarize the connections.
As the power supply voltage, 3.3 V is supplied via USB.

4.2 List of Pins Used

Table 4.1 shows the pins used and their functions.

Table 4.1 Pins used and their functions

Pin	Port Name	I/O	Function
D16	P43	Output	Control of LED0
D17	P44	Output	Control of LED1
D18	P137	Input	Switch (SW_USR) input

5. Software

5.1 Summary of Operation

In this application note, when the initial settings (pin settings) are completed and the main processing (loop) is started, 7-segment LEDs display "00.0".

When the ex_SW or the SW_USR switch is pressed, the 7-segment LED display begins counting up. When the ex_SW or SW_USR switch is again pressed, the counting stops. Thereafter, each time the ex_SW or SW_USR switch is pressed, counting is resumed or stopped.

When counting upward causes the 7-segment LED display to again return to "00.0", one LED is lit. Each time the 7-segment LED display reaches "00.0", an additional LED is lit. When all eight LEDs are lit and the 7-segment LED display again reaches "00.0", the eight LEDs are all extinguished.

Thereafter, the above operation is repeated.

Details are explained in (1) to (3) below.

(1) Pins to be used are set in the **setup** function.

- The pins (segPinA to segPinDP) for driving segments of the 7-segment LEDs are set for digital output.
- The pins (comPin0 to comPin3) for driving commons of the 7-segment LEDs are set for digital output.
- The pin (ex_swPin) for confirmation of the state of the external switch (ex_SW) is set to an input mode in which an internal pull-up resistor is enabled.
- The pin (swPin) for confirmation of the state of the on-board switch (SW_USR) is set for digital input.

(2) The main processing is performed in the **loop** function.

- 10 bits worth, bits 11 to 2, of the time elapsed from startup (in millisecond units) are acquired.
- It is confirmed that the data acquired has changed from the old data (old_time).
- If the data has not changed, processing is ended, and execution returns to the beginning of the loop function.
- If the data has changed (4 milliseconds have elapsed), old_time is changed to the acquired data.
- Processing is switched according to the values of bits 3 and 2.

If (bit 3, bit 2) = (0, 0), the comPin3 pin is set to Low (selection cancelled). Next, segment data for the 10-second digit is determined, and is set at segPin using the set_SEG function. The display digit specification (the comPin0 pin) is set to the com_sel variable.

If (bit 3, bit 2) = (0, 1), the comPin0 pin is set to Low (selection cancelled). Next, segment data for the one-second digit is determined, and is set at segPin using the set_SEG function. At this time, the DP are also set to be lit. The display digit specification (the comPin1 pin) is set to the com_sel variable.

If (bit 3, bit 2) = (1, 0), the comPin1 pin is set to Low (selection cancelled). Next, segment data for the 100-millisecond digit is determined, and is set at segPin using the set_SEG function. The display digit specification (the comPin2 pin) is set to the com_sel variable.

If (bit 3, bit 2) = (1, 1), the comPin2 pin is set to Low (selection cancelled). Next, data for the minute digit is set at segPin using the set_SEG function. The display digit specification (the comPin3 pin) is set to the com_sel variable.

- The display digit specified by the com_sel variable is selected and displayed.

- When counting is permitted (the `time_mode` variable is 1), time counting is performed.

The `precount1` variable (4-millisecond units) is counted up, and upon reaching 25 (when 100 milliseconds have elapsed), `precount1` is cleared, and the `precount2` variable (100-millisecond units) is counted up.

The `precount2` variable (100-millisecond units) is counted up, and upon reaching 10 (when one second has elapsed), the `precount2` variable is cleared, and the `sec_data` variable (1-second units) is counted up.

The `sec_data` variable (1-second units) is counted up, and upon reaching 60 (when one minute has elapsed), the `sec_data` variable is cleared, and the `mini_data` variable (1-minute units) is updated. When the value of `mini_data` is 0xFF, it is set to 0x00. When the value of `mini_data` is not 0xFF, it is shifted one bit to the left, and the LSB (least significant bit) is set (to 1). The value of `mini_data` changes to 0x00, 0x01, 0x03, 0x07, 0x0F, 0x1F, 0x3F, 0x7F, 0xFF.
 - The switch circumstances are checked every 20 milliseconds.

The `prescale4sw` variable is counted up, and upon reaching 5 (20 milliseconds), the `prescale4sw` variable is cleared. The `sw_data` variable is shifted one bit to the left, and bit 0 is set to the result of taking the logical sum of the states of the two switches (switches use negative logic, so the logical product is taken). When either of the switches is pressed, the `time_mode` variable is changed.
- (3) In the **`poll_sw`** function, the state of the **`SW_USR`** switch is confirmed every **10 milliseconds**, and the number of times the switch is pressed is counted.
- The argument segment data is read into the `work_data` working variable.
 - The LSB (least significant bit) of the `work_data` variable is output to the `segPinA` pin, and the `work_data` variable is shifted one bit to the right.
 - The LSB (least significant bit) of the `work_data` variable is output to the `segPinB` pin, and the `work_data` variable is shifted one bit to the right.
 - The LSB (least significant bit) of the `work_data` variable is output to the `segPinC` pin, and the `work_data` variable is shifted one bit to the right.
 - The LSB (least significant bit) of the `work_data` variable is output to the `segPinD` pin, and the `work_data` variable is shifted one bit to the right.
 - The LSB (least significant bit) of the `work_data` variable is output to the `segPinE` pin, and the `work_data` variable is shifted one bit to the right.
 - The LSB (least significant bit) of the `work_data` variable is output to the `segPinF` pin, and the `work_data` variable is shifted one bit to the right.
 - The LSB (least significant bit) of the `work_data` variable is output to the `segPinG` pin, and the `work_data` variable is shifted one bit to the right.
 - The LSB (least significant bit) of the `work_data` variable is output to the `segPinDP` pin.

5.2 List of Constants

Table 5.1 shows constants that are used in the sample code.

Table 5.1 Constants used in sample code

Constant Name	Setting Value	Description
segPinA	0	Number of the pin to control segment A
segPinB	1	Number of the pin to control segment B
segPinC	2	Number of the pin to control segment C
segPinD	3	Number of the pin to control segment D
segPinE	4	Number of the pin to control segment E
segPinF	5	Number of the pin to control segment F
segPinG	6	Number of the pin to control segment G
segPinDP	7	Number of the pin to control segment DP
comPin0	8	Number of the pin to select the 10-second digit
comPin1	9	Number of the pin to select the 1-second digit
comPin2	10	Number of the pin to select the 100-millisecond digit
comPin3	11	Number of the pin to select separate LED
ex_swPin	13	Number of the pin that reads external switch (ex_SW)
swPin	18	Number of the pin that reads SW_USR
SEG_TABLE[]	0x3F	Data to display 0 in a 7-segment LED
	0x06	Data to display 1 in a 7-segment LED
	0x5B	Data to display 2 in a 7-segment LED
	0x4F	Data to display 3 in a 7-segment LED
	0x66	Data to display 4 in a 7-segment LED
	0x6D	Data to display 5 in a 7-segment LED
	0x7D	Data to display 6 in a 7-segment LED
	0x27	Data to display 7 in a 7-segment LED
	0x7F	Data to display 8 in a 7-segment LED
	0x6F	Data to display 9 in a 7-segment LED
	0x00	Data to extinguish a 7-segment LED
HIGH	0x01	High level
LOW	0x00	Low level

5.3 List of Variables

Table 5.1 lists global variables.

Table 5.2 Global variables

Type	Variable Name	Description	Function used
int	old_time	Time elapsed time from previous startup (in millisecond units)	loop()
char	mini_data	Data indicating minutes elapsed: 0x00/0x01/0x03/0x07/0x0F/0x1F/0x3F/0x7F/0xFF	loop()
char	sec_data	Second data	loop()
char	precount1	Used to generate 100-millisecond timing (updated every 4 milliseconds)	loop()
char	Precount2	Used to generate 1-second timing (updated every 100 milliseconds)	loop()
char	digi_sel	Specifies the digit to display (pin numbers: 8 to 11).	loop()
char	prescale4sw	Used to generate 20-second timing	loop()
Int	sw_data	Stores state changes of the switch (initial value is 0xFF).	loop()
Int	time_mode	Flag to control time counting (0: do not count, 1: count)	loop()

5.4 List of Functions

Table 5.3 shows a list of functions.

Table 5.3 List of functions

Function Name	Overview
loop	Main processing (sketch)
setup	Initialization function (sketch)
set_SEG	Function to set display data for 7-segment LEDs (sketch)
pinMode	Specifies the operation mode of a pin (input mode/output mode/input mode with internal pull-up resistor enabled).
digitalWrite	Outputs data to a pin.
digitalRead	Reads the state of a pin.
micros	Returns the time, in microsecond units, from the start of program execution until the present time.
millis	Returns the time, in millisecond units, from the start of program execution until the present time.
delay	Stops the program for the specified time, in millisecond units.
delayMicroseconds	Stops the program for the specified time, in microsecond units.

5.5 Specification of Functions

The function specifications of the sample code are shown below.

[Function name] loop	
Overview	Main function
Header	AR_LIB_PORT.h, AR_LIB_TIME.h, r_cg_macrodriver.h, AR_SKETCH.h, r_cg_userdefine.h
Declaration	void loop(void)
Description	Upon starting, the time from startup is checked, and every 4 milliseconds the output of 7-segment LED digit data is switched. Moreover, when counting is permitted, counting in units of 100 milliseconds, seconds, and minutes is performed. Every 20 milliseconds, the switch states are checked, and if a switch is being pressed, the count permission flag is changed.
Argument	None
Return value	None
[Function name] setup	
Overview	Initialization function
Header	AR_LIB_PORT.h, r_cg_macrodriver.h, r_cg_userdefine.h
Declaration	void setup(void);
Description	Pins used by the program (sketch) are set.
Argument	None
Return value	None
[Function name] set_SEG	
Overview	Function to set display data for 7-segment LEDs
Header	AR_LIB_PORT.h
Declaration	void set_SEG(char data);
Description	Data passed in the argument is set in the corresponding segment control pins as lighting data for the 7-segment LEDs.
Argument	Data : Data for segment to be lit
Return value	None
[Function name] pinMode	
Overview	Function to set the pin function
Header	AR_LIB_PORT.h, r_cg_macrodriver.h, r_cg_userdefine.h
Declaration	void pinMode(uint8_t pin, uint8_t mode)
Description	The pin indicated by the first argument is set to the mode indicated by the second argument.
Argument	uint8_t pin : Number of the pin to be specified uint8_t mode : Specifies the pin mode with OUTPUT/INPUT/INPUT_PULLUP
Return value	None

[Function name] digitalWrite

Overview	Function to output digital data to a pin	
Header	AR_LIB_PORT.h, r_cg_macrodriver.h, r_cg_userdefine.h	
Declaration	void digitalWrite(uint8_t pin, uint8_t value);	
Description	The data indicated by the second argument is output to the pin indicated by the first argument.	
Argument	uint8_t pin :	Number of the pin for data output
	uint8_t value :	Data to output (HIGH/LOW)
Return value	None	

[Function name] digitalRead

Overview	Function to read out digital data from a pin	
Header	AR_LIB_PORT.h, r_cg_macrodriver.h, r_cg_userdefine.h	
Declaration	uint8_t digitalRead(uint8_t pin);	
Description	The state of the pin specified by the argument is read out	
Argument	uint8_t pin :	Number of the pin to be read out
Return value	uint8_t :	Data that was read out (HIGH/LOW)

[Function name] millis

Overview	Function to obtain the elapsed time in millisecond units	
Header	AR_LIB_TIME.h, r_cg_macrodriver.h, r_cg_userdefine.h	
Declaration	uint32_t millis (void);	
Description	Returns the time elapsed from startup, in millisecond units.	
Argument	None	
Return value	uint32_t :	Elapsed time in millisecond units

5.6 Flowcharts

5.6.1 Initial setting function

Figure 5.1 and Figure 5.2 show flowcharts of the initial setting.

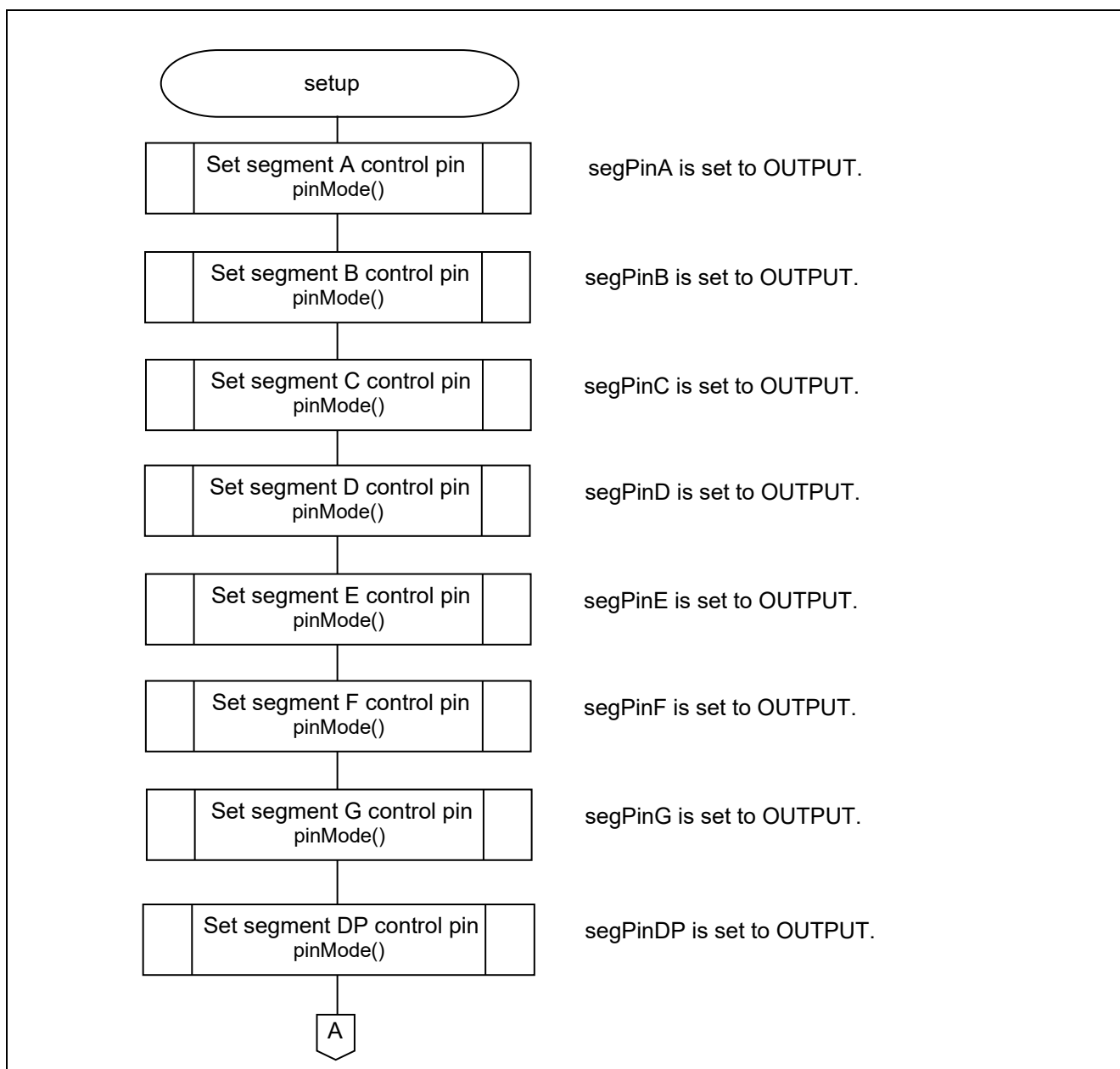


Figure 5.1 Initial setting function (1/2)

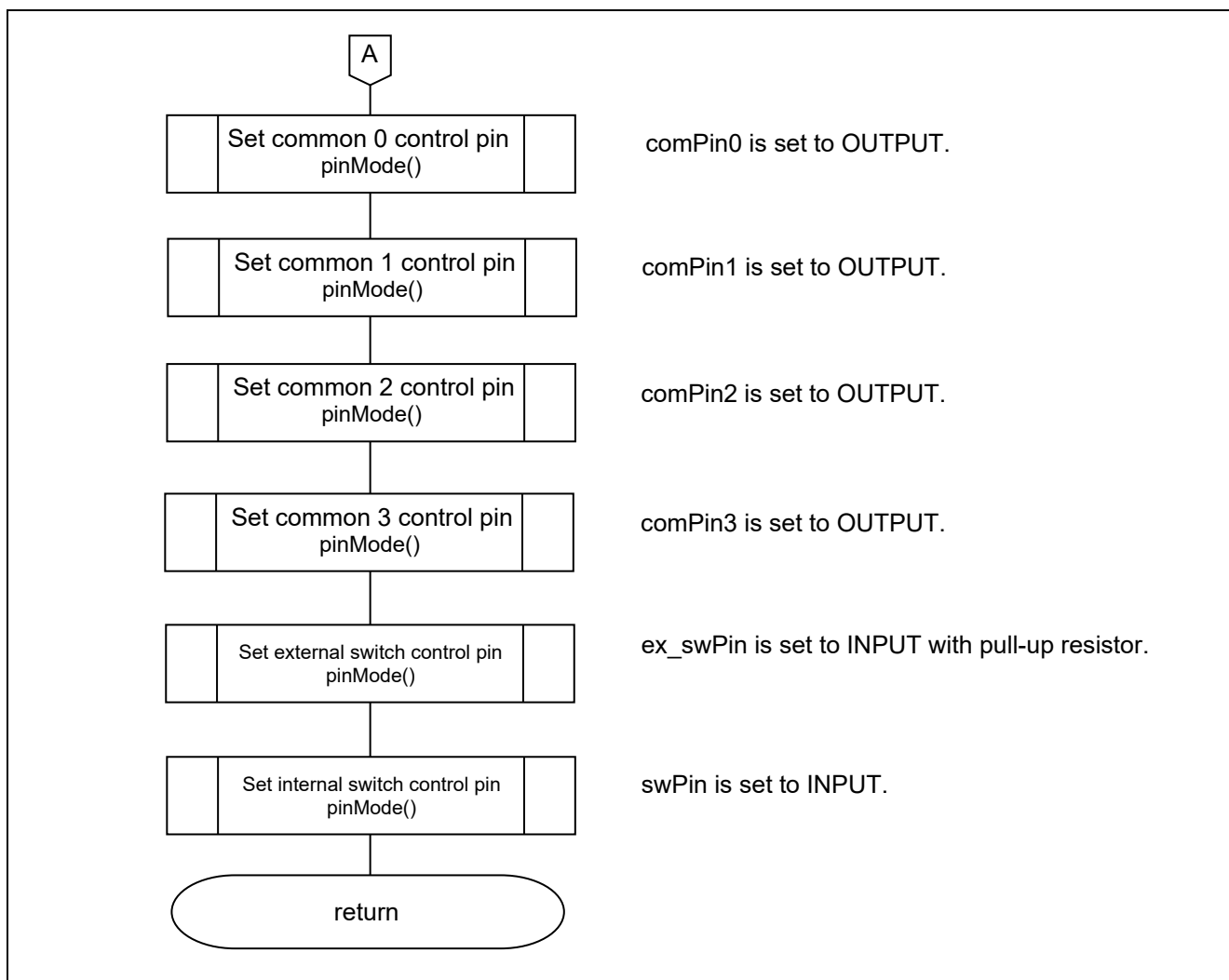


Figure 5.2 Initial setting function (2/2)

5.6.2 Main Processing Function

Figure 5.3 to Figure 5.6 show flowcharts of the main processing function.

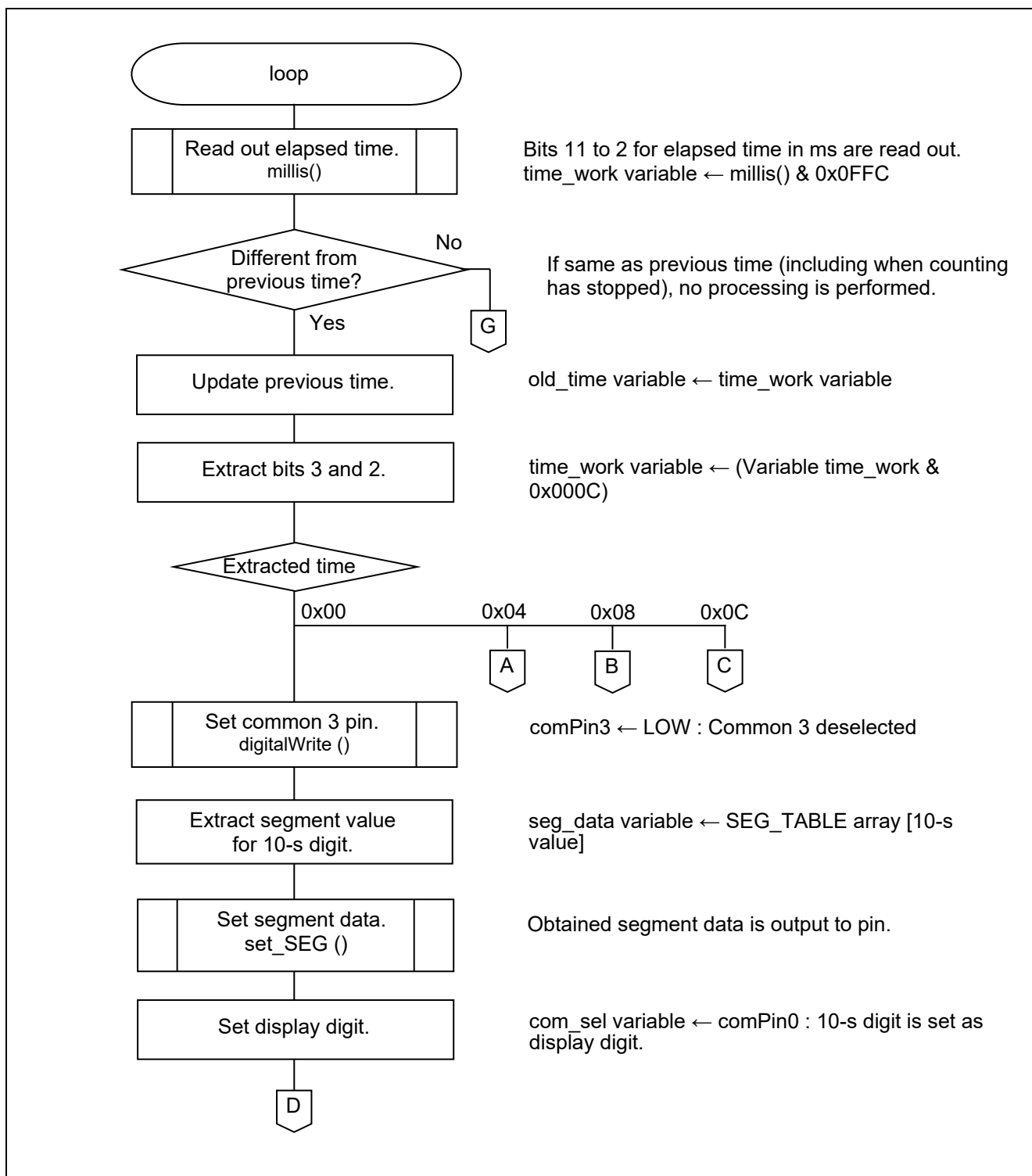


Figure 5.3 Main processing function (1/4)

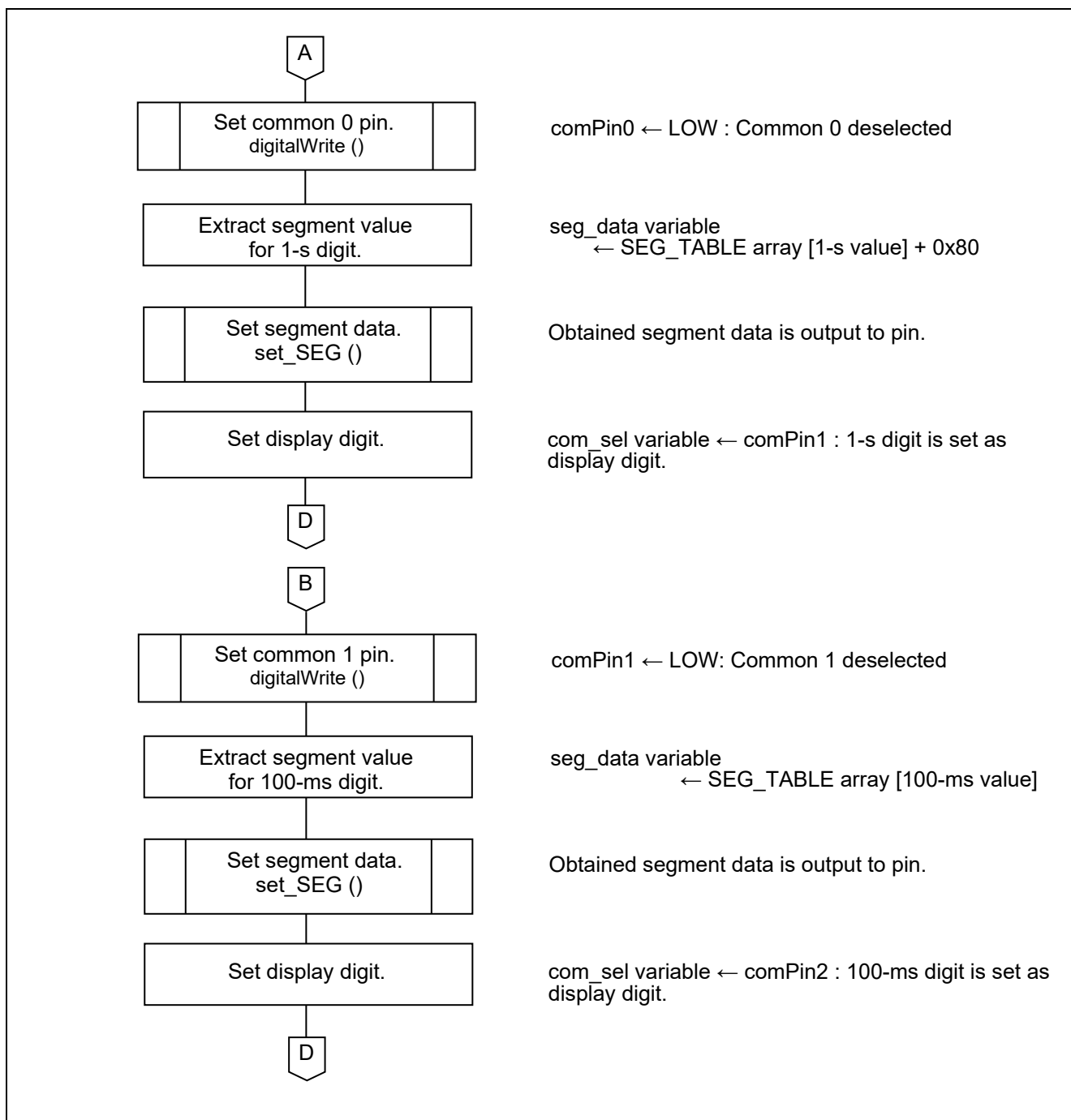


Figure 5.4 Main processing function (2/4)

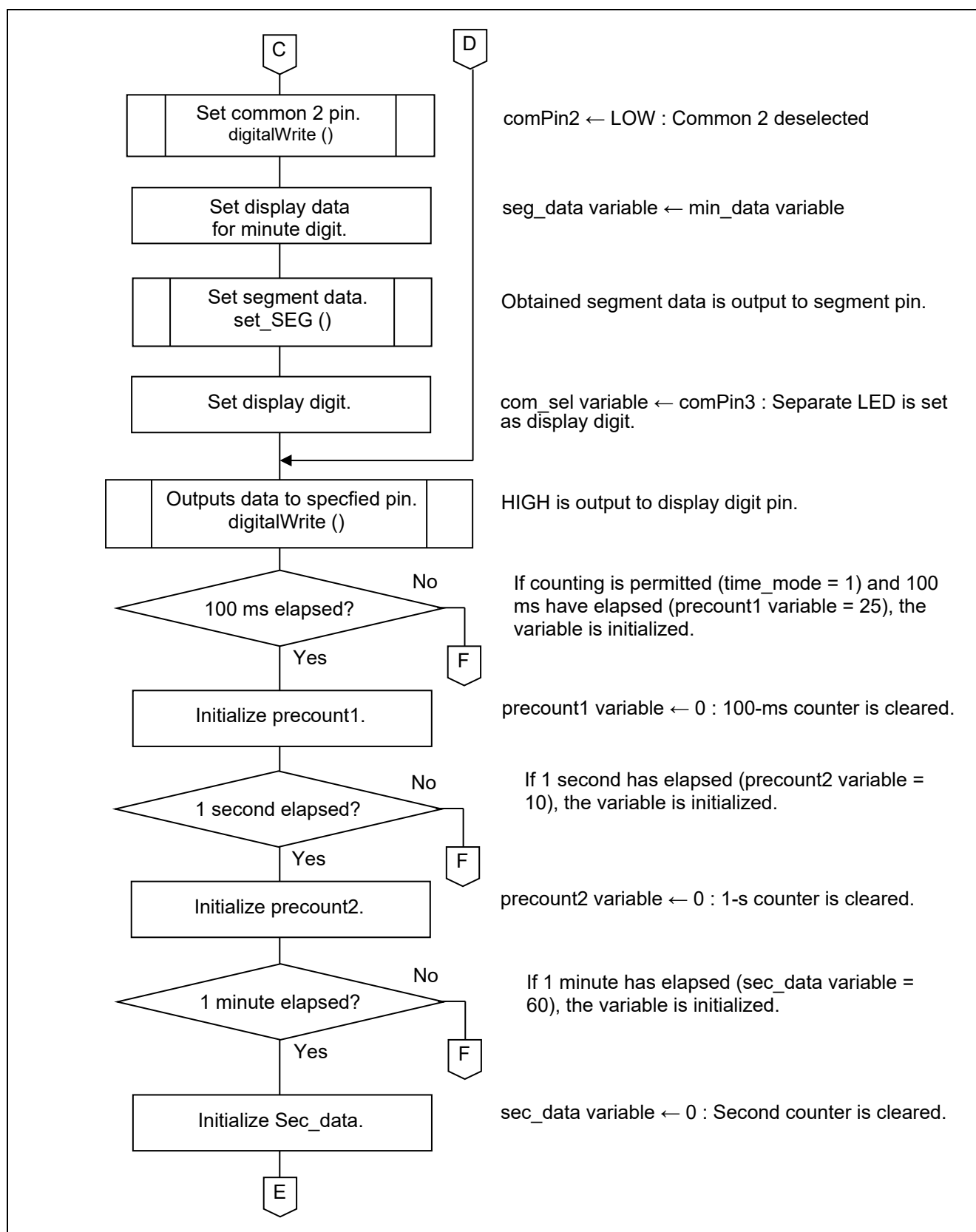


Figure 5.5 Main processing function (3/4)

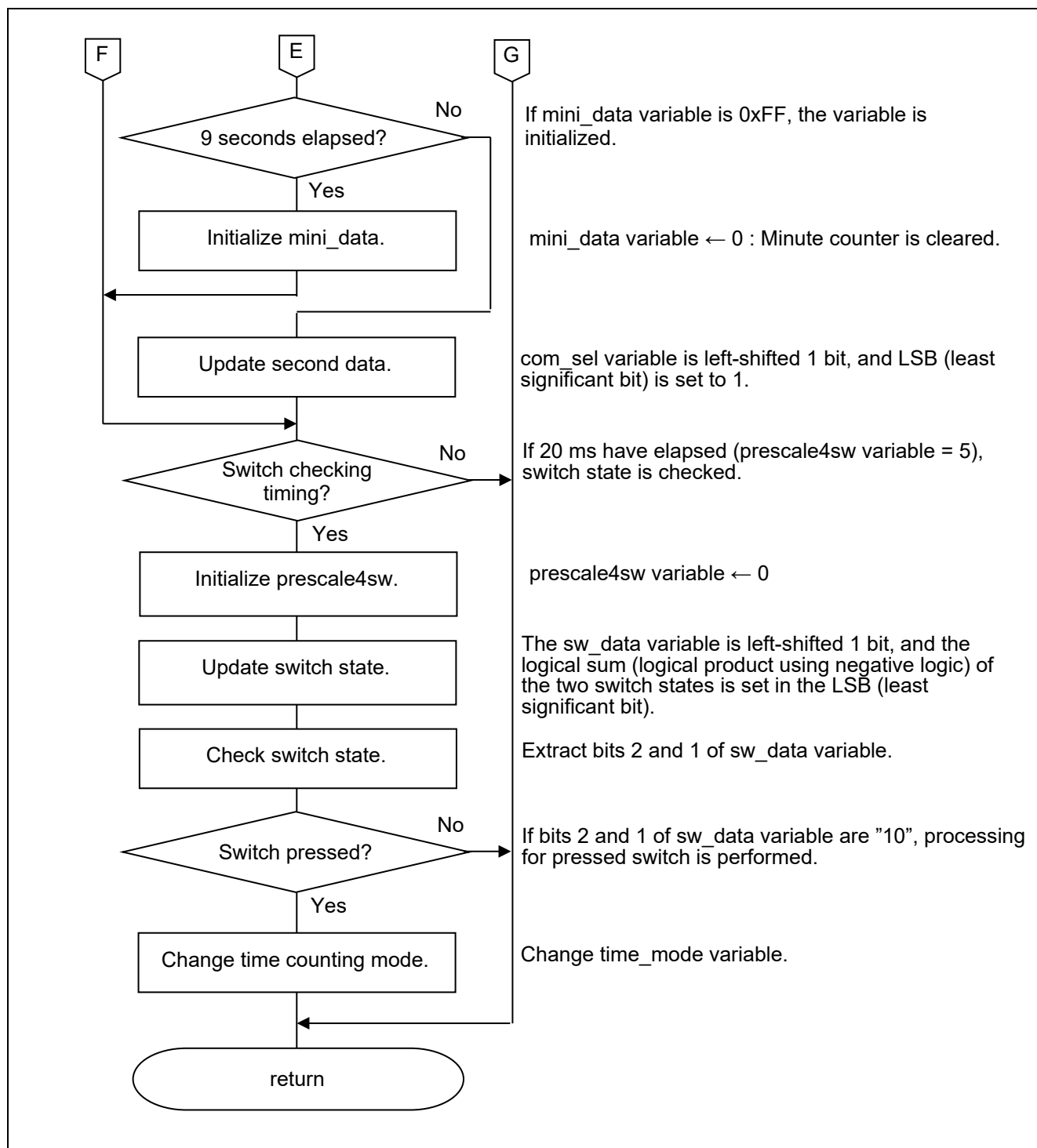


Figure 5.6 Main processing function (4/4)

5.6.3 Function to set display data for 7-segment LEDs

Figure 5.7 and Figure 5.8 show flowcharts of the function to set display data for 7-segment LEDs.

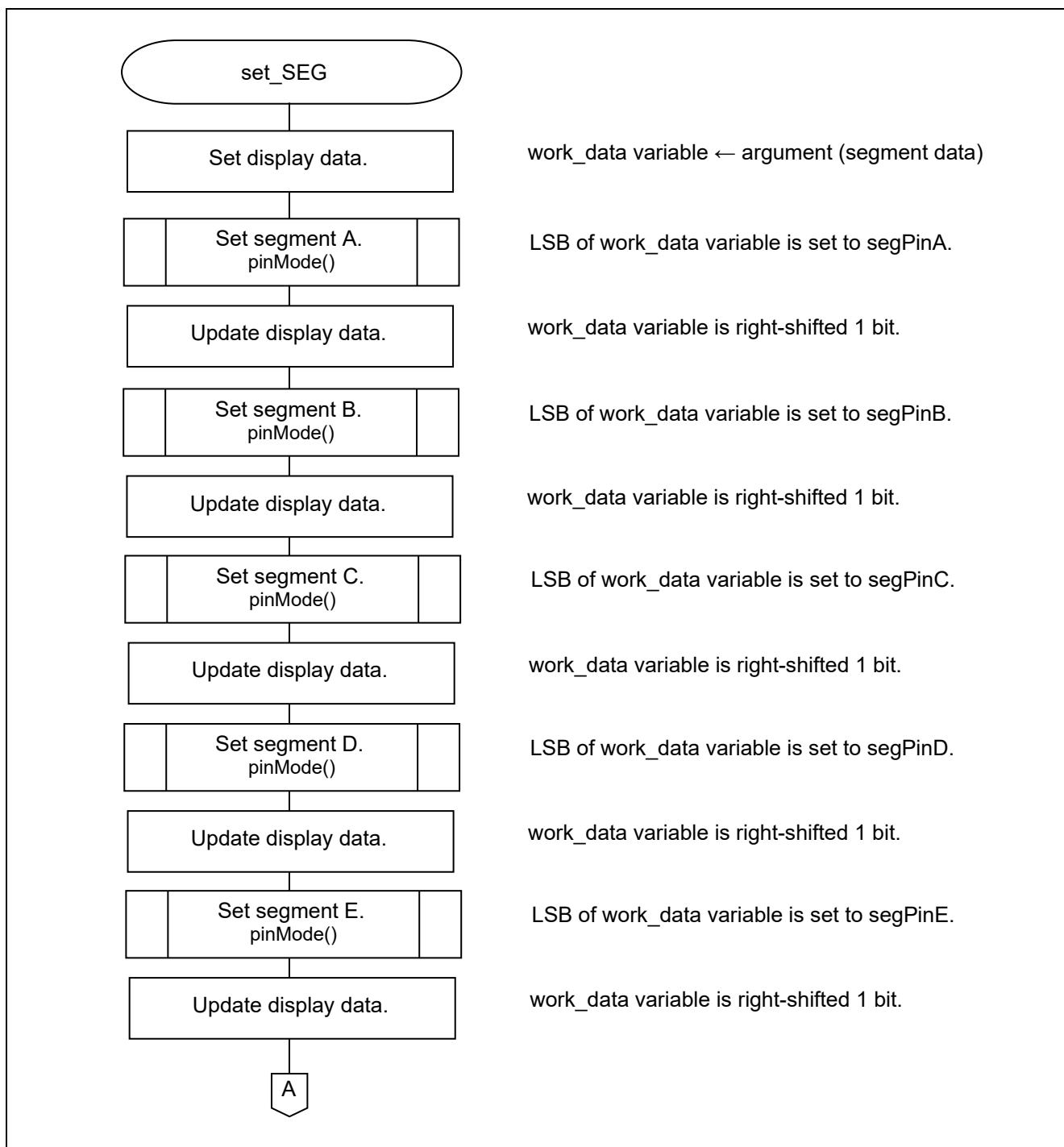


Figure 5.7 Function to set display data for Segment LEDs (1/2)

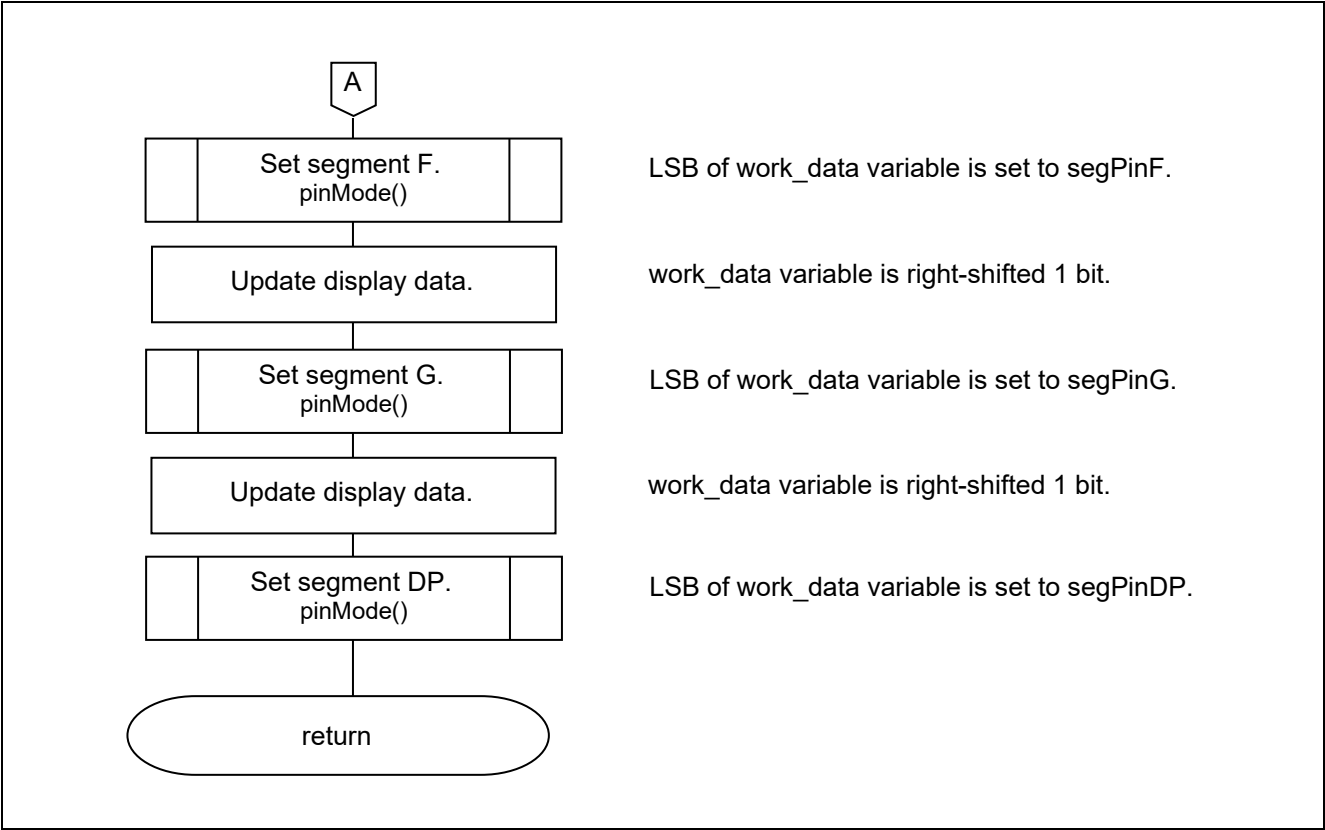


Figure 5.8 Function to set display data for Segment LEDs (2/2)

6. Sample Code

Sample code can be downloaded from the Renesas Electronics website.

7. Reference Documents

RL78/G14 User's Manual: Hardware (R01UH0186)

RL78 family User's Manual: Software (R01US0015)

RL78/G14 Fast Prototyping Board User's Manual (R20UT4573)

RL78 Family Arduino API Introduction Guide (R01AN5413)

(The latest versions can be downloaded from the Renesas Electronics website.)

Technical Update/Technical News

(The latest versions can be downloaded from the Renesas Electronics website.)

Website and Support

Renesas Electronics Website

<http://www.renesas.com/>

Inquiries

<http://www.renesas.com/contact/>

Revision History

Rev.	Date	Description	
		Page	Summary
1.00	July.10.20	—	First Edition

General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Precaution against Electrostatic Discharge (ESD)

A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity.

Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions must be taken for printed circuit boards with mounted semiconductor devices.

2. Processing at power-on

The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power reaches the level at which resetting is specified.

3. Input of signal during power-off state

Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.

4. Handling of unused pins

Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible.

5. Clock signals

After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable.

6. Voltage application waveform at input pin

Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between V_{IL} (Max.) and V_{IH} (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between V_{IL} (Max.) and V_{IH} (Min.).

7. Prohibition of access to reserved addresses

Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not guaranteed.

8. Differences between products

Before changing from one product to another, for example to a product with a different part number, confirm that the change will not lead to problems. The characteristics of a microprocessing unit or microcontroller unit products in the same group but having a different part number might differ in terms of internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

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